PMP8590 REV_B BOM

Quantity Designator	Value	Description	PackageReference	PartNumber	Manufacturer
1 C1	2200pF	CAP, CERM, 2200pF, 630V, +/-5%, C0G/NP0, 1206	1206	C3216C0G2J222J	TDK
1 C2	6.8uF	CAP, AL, 6.8uF, 400V, +/-20%, Irms=100mA, TH	10x16	EKXG401ELL6R8MJ16S	Nippon Chemi-Con
1 C3	10uF	CAP, AL, 10uF, 400V, +/-20%, Irms=350mA, TH	10x20	EKXG401ELL100MJ20S	Nippon Chemi-Con
1 C4	100nF	Capacitor, Film, 0.1uF, 275VAC, ±20%	0.265x 0.433 inch	ECQU2A104ML	Panasonic
1 C5	220uF	CAP, AL, 220uF, 35V, +/-20%, ohm, SMD	JA0	EMVK350ADA221MJA0G	Nippon Chemi-Con
1 C6	3.3uF	CAP, CERM, 3.3uF, 50V, +/-20%, X7R, 1210	1210	C3225X7R1H335M	TDK
1 C7	22uF	CAP, AL, 22uF, 25V, +/-20%, 0.7 ohm, SMD	SMT Radial C	EEE-FK1E220R	Panasonic
1 C8	0.1uF	CAP, CERM, 0.1uF, 50V, +/-10%, X7R, 0603	0603	C1608X7R1H104K	TDK
1 C10	1000pF	CAP, CERM, 1000pF, 300V, +/-20%, Y5U, Radial Disc 7.5mm, ls=7.5	Radial Disc 7.5mm, Is=7.5	VY2102M29Y5UG63V7	Vishay-Bccomponents
1 D1	RH06-T	Diode, Switching-Bridge, 600V, 0.5A, MiniDIP	MiniDIP	RH06-T	Diodes Inc.
1 D3	CMR1U-02M	Diode, Ultrafast, 200V, 1A, SMA	SMA	CMR1U-02M	Central Semiconductor
1 D4	BAS21	Diode, Switching, 200-mA, 250V, 385mW	SOT23	BAS21xT1G	On Semi
1 D7	US1K	Diode, Ultrafast, 800V, 1A, SMA	SMA	US1K-13-F	Diodes Inc.
1 L1	1mH	Inductor, Shielded Drum Core, Metal Composite, 1mH, 0.5A, 1.7 ohm, TH	Dia 8x10mm	768772102	Wurth Elektronik eiSos
1 L2	20 mH	Inductor, Coupled ±30%	7.5x15 mm	744821120	WE
1 R1	6.8k	RES, 6.8k ohm, 5%, 0.25W, 1206	1206	CRCW12066K80JNEA	Vishay-Dale
1 R2	120k	RES, 120k ohm, 5%, 0.25W, 1206	1206	CRCW1206120KJNEA	Vishay-Dale
1 R3	10 Ohm	Resistor, Fused, 2.5W, ±1%	{Size}	PWR4522AS10R0JA	Bourns
1 R4	S10K275E2	Varistor, 275V, 25A	0.472 x 0.213 inch	SIOV-S10K275E2	Epcos
1 R5	100	RES, 100 ohm, 1%, 0.125W, 0805	0805	CRCW0805100RFKEA	Vishay-Dale
1 R6	33.2	RES, 33.2 ohm, 1%, 0.1W, 0603	0603	CRCW060333R2FKEA	Vishay-Dale
2 R7, R9	100k	RES, 100k ohm, 1%, 0.1W, 0603	0603	CRCW0603100KFKEA	Vishay-Dale
1 R8	1.40k	RES, 1.40k ohm, 1%, 0.1W, 0603	0603	CRCW06031K40FKEA	Vishay-Dale
1 R10	28.0k	RES, 28.0k ohm, 1%, 0.1W, 0603	0603	CRCW060328K0FKEA	Vishay-Dale
1 T1	1.5mH	Transformer, 290 W	21 x 25 mm	750811445	Wuerth
3 TP1, TP2, TP3	Red	Test Point, TH, Miniature, Red	Keystone5000	5000	Keystone
1 TP4	Black	Test Point, TH, Miniature, Black	Keystone5001	5001	Keystone
1 U1	UCC28910D	LOW STAND-BY POWER, CV / CC PWM HV SWITCHER WITH PRIMARY SIDE REGULATION	SOIC7	UCC28910D	Texas Instruments

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